

AF  
IFW



RESPONSE UNDER 37 C.F.R. § 1.116  
-- EXPEDITED PROCEDURE --  
EXAMINING GROUP 2100

Our Docket No.: 042390.P9043

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Subramaniyam	)	Examiner: Phan, Raymond Ngan
Application No.: 09/669,034	)	Art Group: 2111
Filed: September 25, 2000	)	
For: A Method and Apparatus for Lowering	)	
the Die Temperature of a	)	
Microprocessor and Maintaining the	)	
Temperature Below the Die Burn Out	)	

**RESPONSE AFTER FINAL**

Mail Stop: AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Final Office Action mailed on November 16, 2005, which was made final, applicant submits this Amendment After Final Action for consideration.

**FIRST CLASS CERTIFICATE OF MAILING/FACSIMILE**

I hereby certify that I am causing the above-referenced correspondence to be facsimile transmitted and to be deposited with the United States Postal Service as first class mail with sufficient postage on the date indicated below and that this paper or fee has been addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

January 17, 2006  
Date of Deposit

Leah Schwenke  
Name of Person Mailing Correspondence

	January 17, 2006
Signature	Date

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